

APPROVAL SHEET

客户名称: _ CUSTOMER _	
品 名: PART NAME	CMOS Camera Module
规 格: SPECIFICATION	JSK-RA045-V2.0
版本号: VERSION	Second Version
日 期 : DATE :	2020-4-15

			客	户 (CUSTOME	R)
APPROVAL			APPROVAL		
拟制	审核	批准	拟制	审核	批准
(DESIGNER)	(CHECKER)	(APPROVER)	(DESIGNER)	(CHECCKER)	(APPROVER)
Fei	<u>Huang.J</u>	<u>Kratos</u>			



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Notes:

This specification shows the main information of the camera module. It contains the component structure and main functions of the camera module, as well as the information of quality inspection and reliability test.

2. Feature

1 / 2.7 "CMOS image sensor, lens and FPC, AR0230 are ultra clear CMOS image sensor chips developed by MgO Electronics Co., Ltd. It uses the company's latest pixel technology and image processing technology to provide customers with cost-effective photography solutions. This product can output different sizes of images, such as VGA, CIF, QVGA. Ensure the original picture quality, faster frame rate. Users can set the register to control the image of the 2-wire performance bidirectional synchronous serial bus. The sensor can output 1920x1080 30 frames per second. It also has AEC, AWB, LSC, etc.

DVP Parallel Interface Fixed Focus 2MP Camera Module

Mainly used in

Digital products

Computer camera

MIPI INTERFACE (module type : fixde focus)

Mid tablet

Vehicle data recorder

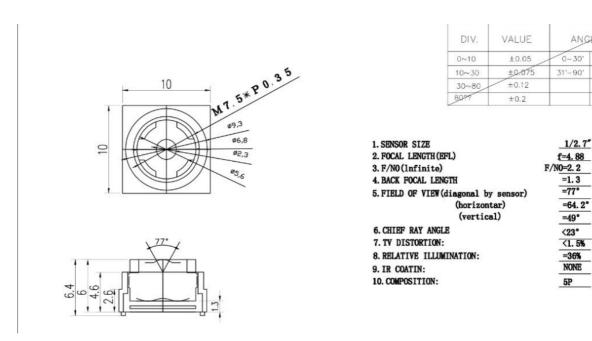
Other



3. Key specification datasheet

Image Sensor	AR0230			
EFL	3.29mm			
F.NO	2.8			
Pixel	1920 x 1080			
View Angle	68.7°			
Lens Type	1/4 inch			
Lens Dimensions	8.00 x 8.00 x 4.90 mm			
Module Size	18.50 x 12.50			
Module Type	Fixed Focus			
Interface	MIPI and DVP Parallel			

Camera lens :



ANGLE 0-30

1/2.7"

=1.3

=77° =64. 2°

=49°

<23°

<1.5%

=36% NONE

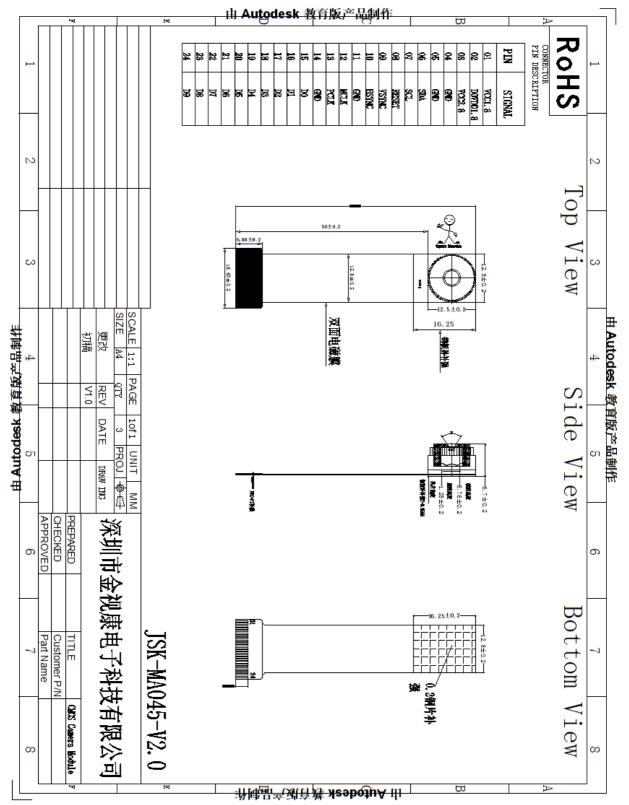
5P

±0.3°

±0.5



5. Module mechanical drawing





6. Reliability test

N O.	Test Item		Result	Qty	test equipment	Notes
	High and low temperature	High Tem 65°C 70 小时	ОК	5	High tem box	
1	experiment (storage)	Low Tem -20°C 70 小时	ОК	5	Low tem box	
2	High and low temperature cycle test	Low Tem -20°C(30min)to High Tem 70° (30min)96H	ОК	5	High and low temperature box	
3	Low temperature operation			5	Low tem box	
4	High temperature operation	65°96H Temperature rise and fall each (30min)	ОК	5	High temperature incubator	
5	Tempeature and	High Tem 65°C humidity 80% 24H	ОК	5	High tem box	
6	humidity test (storage)	Low Tem -20°C humidity 80% 24H	ОК	5	Low tem box	
7	life test	The switch spacing is 3 seconds, and the performance is tested every 2000 times, totally 5 groups	ОК	5	Transfer box	
		Height 1500mm, 10 times				
8	Drop test	10. Free fall in Y, z directions	ОК	5	Drop machine	
		Frequency: 10hz55hz, amplitude: 1mm,				
9	vibration test	10. Free vibration in Y, z directions, closed-loop sweep frequenc	ОК	5	Vibrator	
10		Tensile test, vertical pull up 1.5kgf	ОК	5	Manual tension gauge	
11	Push pull test	Thrust test, horizontal pushing forward 2.0 KGF	ОК	5	Manual tension gauge	
12	CAM Adhesion force test	CAM Adhesion force between base and shell, greater than 0.6kg (vertical direction)	ОК	5	Manual tension gauge	



7. Image specification

	Test environment			standard
Test Item	colour temperature	light	Test objectives	Pass
Resolution test (MTF)				>
center	D65	N/A	Test chart	≧ 40%
Angle				≧ 30%
lack fidelity	D65	N/A	Test chart	≦3%
Gray Test				
Vi (i = 1)	D65	N/A	Test chart	≧5
∆Yi (i= 2∼6)				≧10
shadow	D50+/-270	N/A	Imaging chip	≦30%
Image test		N/A	Imaging chip	
Dead zone pixels	D50+/-270			0
Injured pixels				24
Particle (swarm)				0
Weak defect				0
Line defect				0
White pixels in dark mode		30+/-10	Dark field of view	0
Line defects in dark mode		30+/-10	Dark field of view	0